

# VAOL-S12WR4 1206 Package Size SMD LED WHITE

### **Features**

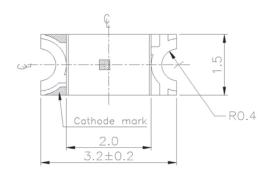
- · Fit automatic placement equipment
- Fit compatible with infrared and vapor phase relow solder process
- · Pb-free
- · RoHS compliant



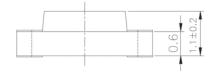
### **Descriptions**

- · For higher packing density
- · For minature applications
- · Yellow Diffusion Lens
- · Chip material: InGaN
- · Emmiting color: white

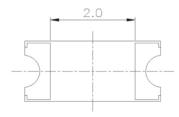
# **Package Outline Dimensions**

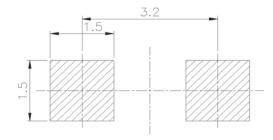






For reflow soldering (propose)





**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm



### **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	VR	5	V
Forward Current	${ m I}_{ m F}$	25	mA
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\mathbb{C}$
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$
Electrostatic Discharge(HBM)	ESD	150	V
Power Dissipation	Pd	110	mW
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	100	mA
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.	

## Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	45	72	112	mcd	
Viewing Angle	2θ 1/2		140		deg	IF=5mA
Forward Voltage	VF	2.70	2.90	3.15	V	
Reverse Current	Ir			50	$\mu$ A	V <sub>R</sub> =5V

Bin Range Of Luminous Intensity & Forward Voltage

S	ymbol	Bin Code	Min.	Max.	Unit	Condition
Iv	P	45.0	72.0	mcd V	I <sub>F</sub> =5mA	
	Q	72.0	112			
VF	15	2.70	2.85			
	16	2.85	3.00			
	17	3.00	3.15			

### Notes:

- 1.Tolerance of Luminous Intensity ±10%
- 2.Tolerance of Forward Voltage ±0.1V



### **Chromaticity Coordinates Specifications for BIN Grading**

 $I_F = 5mA$ 

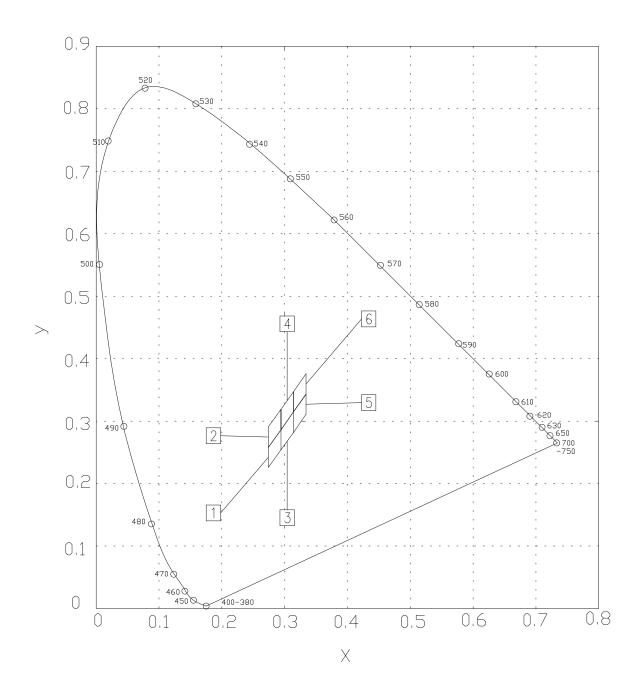
			II JIIIA
Groups	Bin Code	CIE_x	CIE_y
	1	0.274	0.226
		0.274	0.258
		0.294	0.286
		0.294	0.254
	2	0.274	0.258
		0.274	0.291
		0.294	0.319
		0.294	0.286
		0.294	0.254
	2	0.294	0.286
	3	0.314	0.315
A		0.314	0.282
A	4	0.294	0.286
		0.294	0.319
		0.314	0.347
		0.314	0.315
	5	0.314	0.282
		0.314	0.315
		0.334	0.343
		0.334	0.311
	6	0.314	0.315
		0.314	0.347
		0.334	0.376
		0.334	0.343

### Notes:

- 1. The C.I.E. 1931 chromaticity diagram (Tolerance  $\pm 0.01$ ).
- 2. The products are sensitive to static electricity and care must be fully taken when handling products.

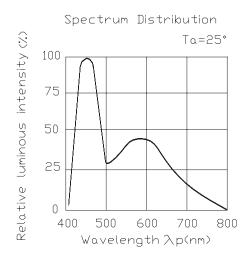


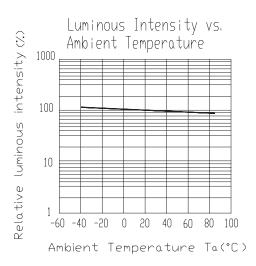
# **CIE Chromaticity Diagram**

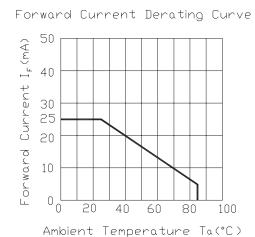


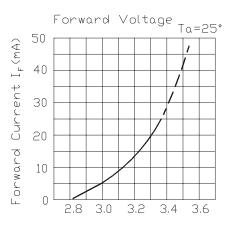


# **Typical Elctro-Optical Characteristics Curves**

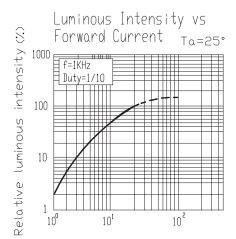


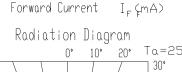


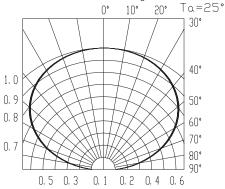




Forward Voltage(V)-volts

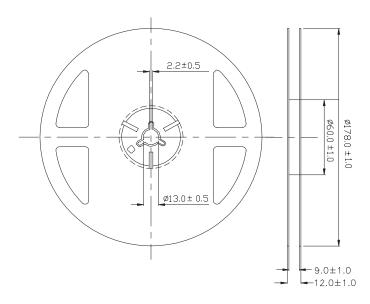








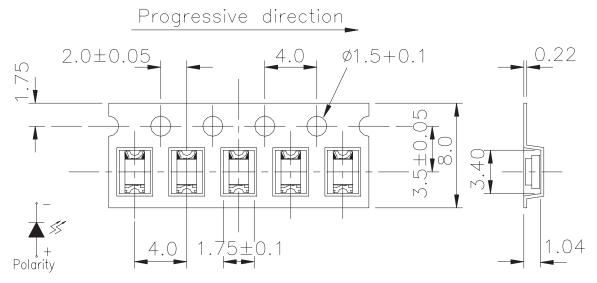
# **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

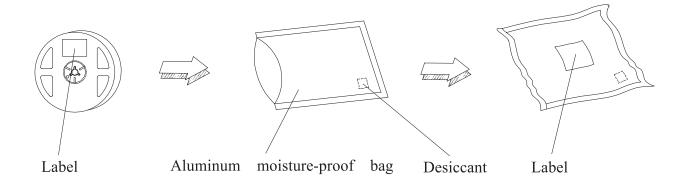


### Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

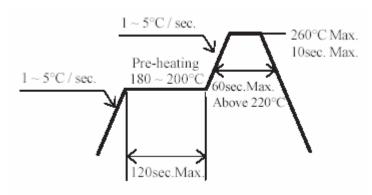
### **Moisture Resistant Packaging**





### **Soldering Condition**

1.Pb-free solder temperature profile



- 2.Reflow soldering should not be done more than two times.
- 3 When soldering, do not put stress on the LEDs during heating.
- 4 After soldering, do not warp the circuit board.

#### Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### **Rated Lumen Maintenance Life**

(L50) at 10,000 hour lifetime